IN THE CLAIMS:

Claim 1 (Currently Amended): A liquid crystal display device, comprising:

a liquid crystal display panel having a plurality of liquid crystal cells arranged in a matrix configuration;

a printed circuit board having a drive circuit mounted thereon to drive the liquid crystal display panel;

a supporter main for supporting the liquid crystal display panel;

at least one hole formed ~~in~~ through a thickness of the printed circuit board; and

at least one projected ~~parts~~ part protruding from the supporter main,

wherein the projected part is inserted into the hole to affix the printed circuit board to the supporter main and the projected part has a projecting length less than the thickness of the printed circuit board.

Claim 2 (Original): The device according to claim 1, wherein a diameter of the projected part is larger than a minor diameter of the hole by as much as about 0.02~0.05mm.

Claim 3 (Original): The device according to claim 2, wherein the hole has an elliptical shape.

Claim 4 (Original): The device according to claim 1, wherein the projected part includes a plurality of protrusions separated from each other by a first gap.

Claim 5 (Original): The device according to claim 4, wherein the hole has an elliptical shape.

Claim 6 (Original): The device according to claim 5, wherein the first gap extends along a direction parallel to a major diameter of the elliptical shaped hole.

Claim 7 (Original): The device according to claim 1, wherein the hole has an elliptical shape.

Claim 8 (Currently Amended): A method of fabricating a liquid crystal display device, comprising:

providing a liquid crystal display panel having a plurality of liquid crystal cells arranged in a matrix configuration;

providing a printed circuit board having a drive circuit mounted thereon to drive the liquid crystal display panel and at least one hole formed ~~in~~ through a thickness of the printed circuit board;

providing a supporter main for supporting the liquid crystal display panel and forming at least one projected ~~parts~~ part protruding from the supporter main; and

inserting the projected part into the hole to affix the printed circuit board to the supporter main,

wherein a projecting length of the projected part is less than the thickness of the printed circuit board.

Claim 9 (Original): The method according to claim 8, wherein a diameter of the projected part is larger than a minor diameter of the hole by as much as about 0.02~0.05mm.

Claim 10 (Original): The method according to claim 9, wherein the hole has an elliptical shape.

Claim 11 (Original): The method according to claim 8, wherein the projected part includes a plurality of protrusions separated from each other by a first gap.

Claim 12 (Original): The method according to claim 11, wherein the hole has an elliptical shape.

Claim 13 (Original): The method according to claim 12, wherein the first gap extends along a direction parallel to a major diameter of the elliptical shaped hole.

Claim 14 (Original): The method according to claim 8, wherein the hole has an elliptical shape.